

**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

**Title of  
Invention****LIGHT EMITTING DIODE HAVING AN ADHESIVE LAYER AND A  
MANUFACTURING METHOD THEREOF**

Application Number :

Date :

First Named Applicant: Min-Hsun Hsieh

Confirmation Number:

Attorney Docket Number: KYCP0009USA1

I hereby certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.

I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.

**Submitted By:****Elec. Sign.**Winston Hsu  
Registered Number: 41,526

Winston Hsu

Documents being submitted:	Files
us-request	KYCP0009-1-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	KYCP0009-1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	KYCP0009-1-ASS1.tif
application-body	KYCP0009-1-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd kycp0009usa1-01.tif kycp0009usa1-02.tif kycp0009usa1-03.tif kycp0009usa1-04.tif kycp0009usa1-05.tif
us-declaration	KYCP0009-1-ASS2.tif
us-declaration	KYCP0009-1DEC1.tif
us-declaration	KYCP0009-1DEC2.tif
Comments	